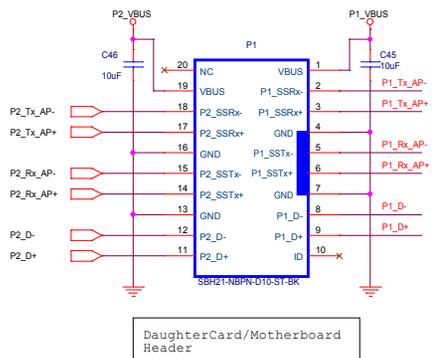
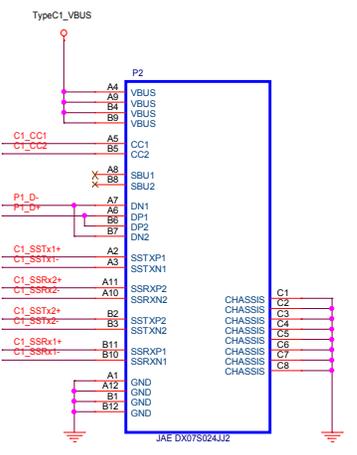
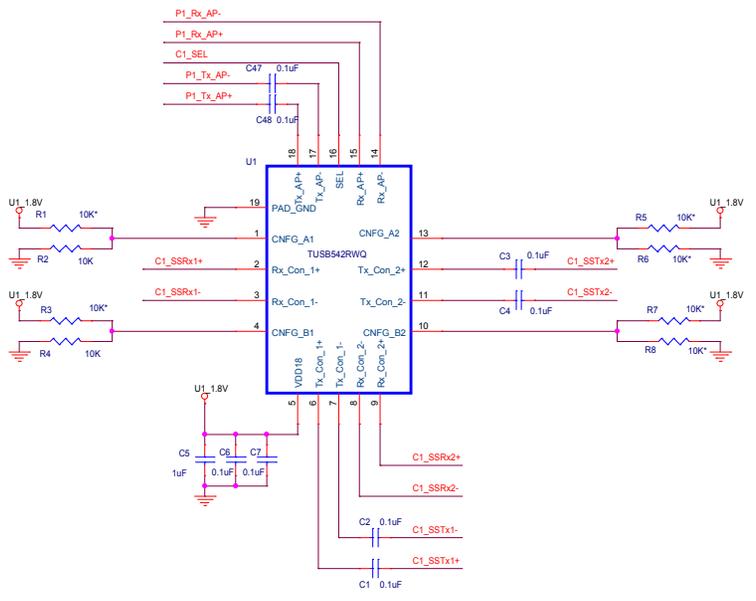


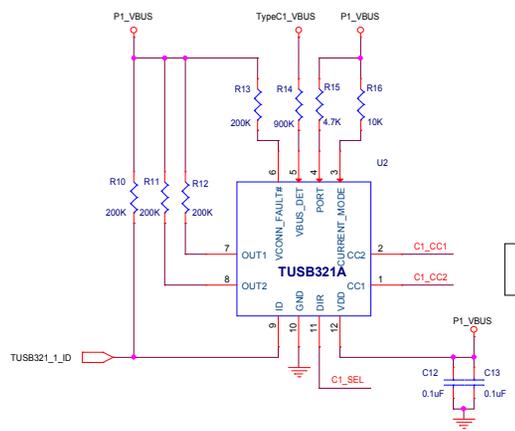
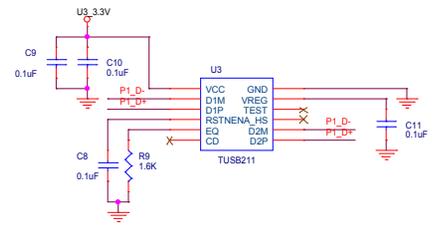
Title		
TIDA00728 Front Port Type C USB Extender		
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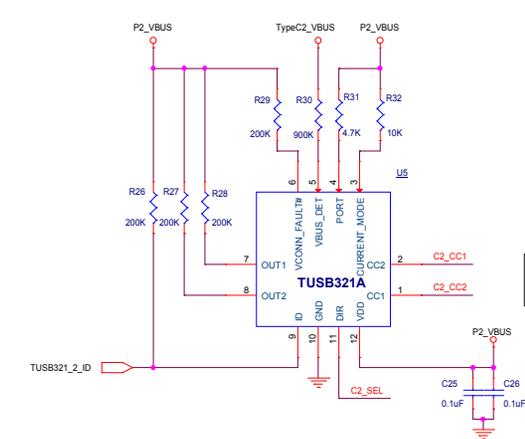
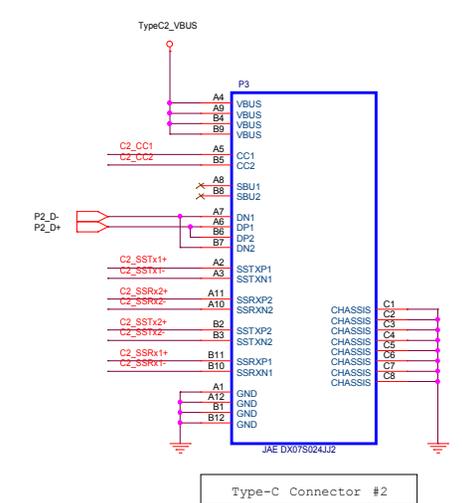
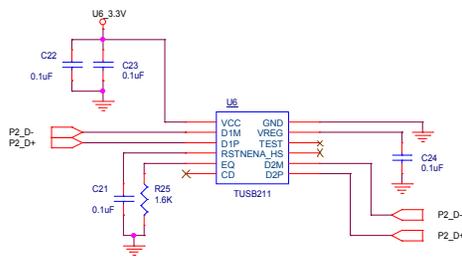
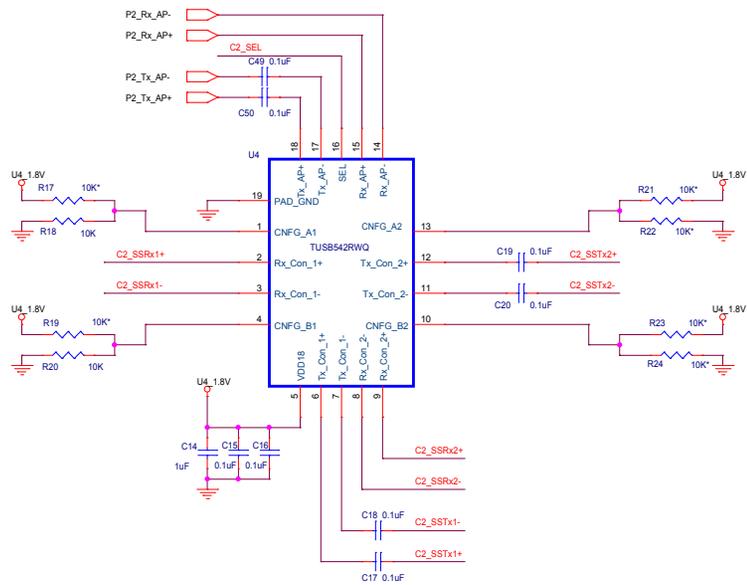
DaughterCard/Motherboard Header



Type-C Connector #1

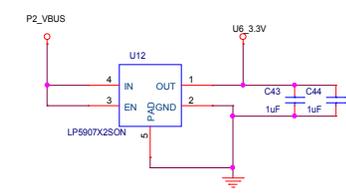
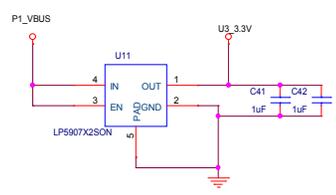
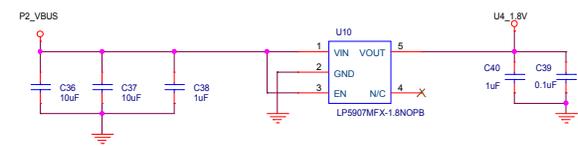
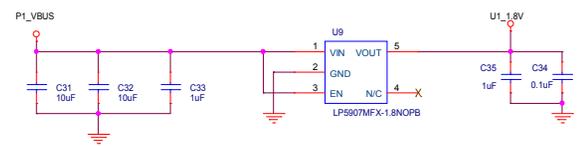
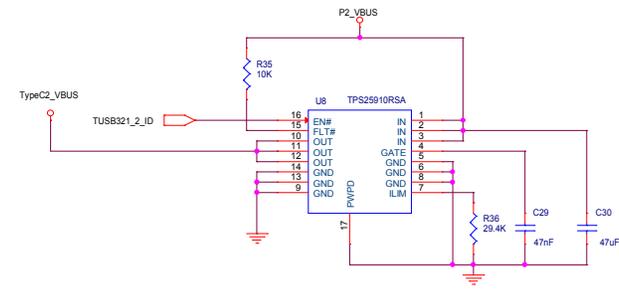
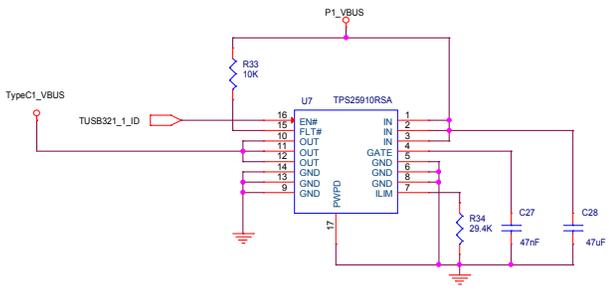


Note:
C11 & C12 swapped as DIR and SEL are
opposite for TUSB542 and TUSB321.



Note:
CC1 & CC2 swapped as DIR and SEL are
opposite for TUSB542 and TUSB321

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